



Silicon Gate MOS 8080A

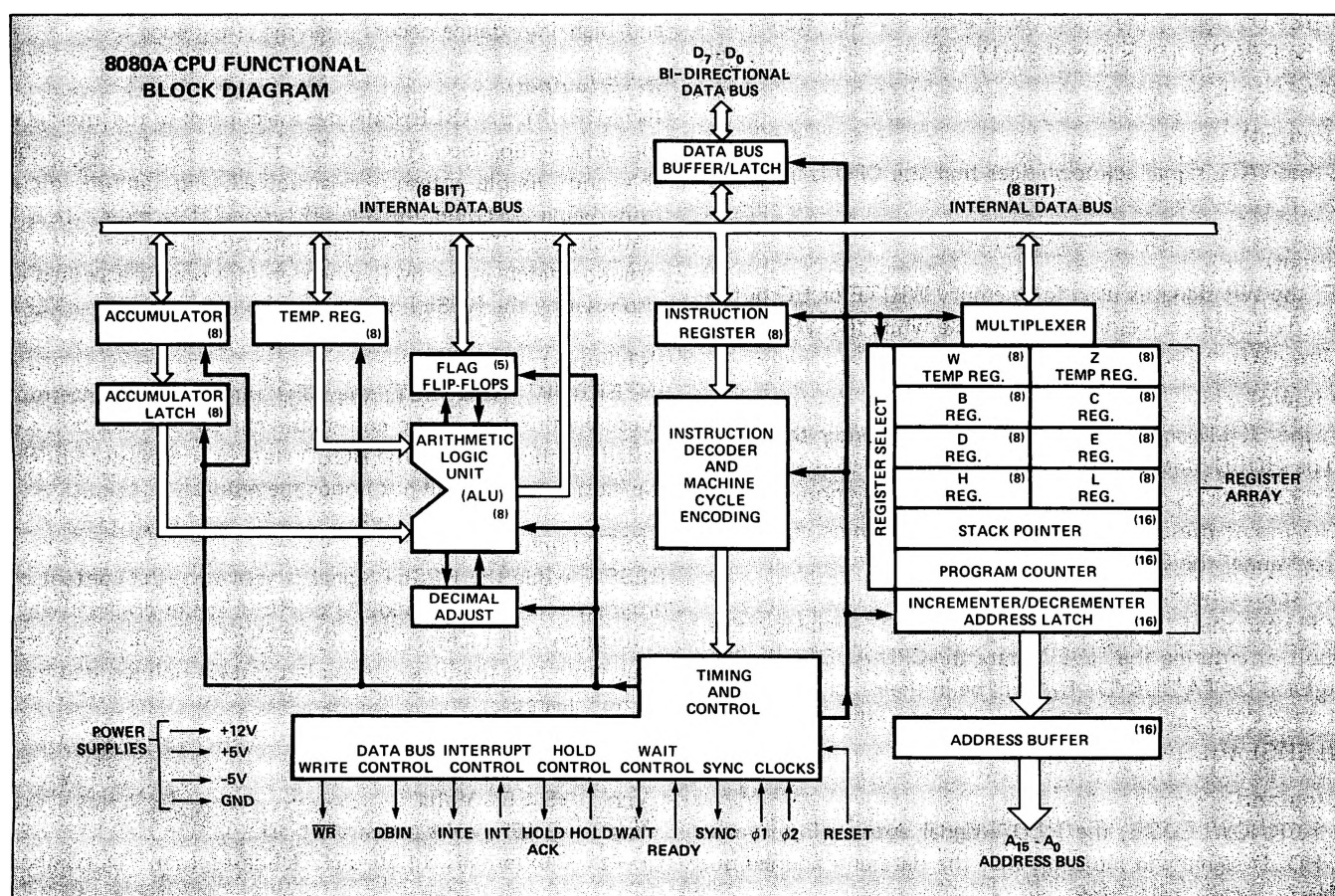
SINGLE CHIP 8-BIT N-CHANNEL MICROPROCESSOR

The 8080A is functionally and electrically compatible with the Intel® 8080.

- TTL Drive Capability
- 2 μ s Instruction Cycle
- Powerful Problem Solving Instruction Set
- Six General Purpose Registers and an Accumulator
- Sixteen Bit Program Counter for Directly Addressing up to 64K Bytes of Memory
- Sixteen Bit Stack Pointer and Stack Manipulation Instructions for Rapid Switching of the Program Environment
- Decimal, Binary and Double Precision Arithmetic
- Ability to Provide Priority Vectored Interrupts
- 512 Directly Addressed I/O Ports

The Intel® 8080A is a complete 8-bit parallel central processing unit (CPU). It is fabricated on a single LSI chip using Intel's n-channel silicon gate MOS process. This offers the user a high performance solution to control and processing applications. The 8080A contains six 8-bit general purpose working registers and an accumulator. The six general purpose registers may be addressed individually or in pairs providing both single and double precision operators. Arithmetic and logical instructions set or reset four testable flags. A fifth flag provides decimal arithmetic operation.

The 8080A has an external stack feature wherein any portion of memory may be used as a last in/first out stack to store/retrieve the contents of the accumulator, flags, program counter and all of the six general purpose registers. The sixteen bit stack pointer controls the addressing of this external stack. This stack gives the 8080A the ability to easily handle multiple level priority interrupts by rapidly storing and restoring processor status. It also provides almost unlimited subroutine nesting. This microprocessor has been designed to simplify systems design. Separate 16-line address and 8-line bi-directional data busses are used to facilitate easy interface to memory and I/O. Signals to control the interface to memory and I/O are provided directly by the 8080A. Ultimate control of the address and data busses resides with the HOLD signal. It provides the ability to suspend processor operation and force the address and data busses into a high impedance state. This permits OR-tying these busses with other controlling devices for (DMA) direct memory access or multi-processor operation.



SILICON GATE MOS 8080A

8080A FUNCTIONAL PIN DEFINITION

The following describes the function of all of the 8080A I/O pins. Several of the descriptions refer to internal timing periods.

A₁₅-A₀ (output three-state)

ADDRESS BUS; the address bus provides the address to memory (up to 64K 8-bit words) or denotes the I/O device number for up to 256 input and 256 output devices. A₀ is the least significant address bit.

D₇-D₀ (input/output three-state)

DATA BUS; the data bus provides bi-directional communication between the CPU, memory, and I/O devices for instructions and data transfers. Also, during the first clock cycle of each machine cycle, the 8080A outputs a status word on the data bus that describes the current machine cycle. D₀ is the least significant bit.

SYNC (output)

SYNCHRONIZING SIGNAL; the SYNC pin provides a signal to indicate the beginning of each machine cycle.

DBIN (output)

DATA BUS IN; the DBIN signal indicates to external circuits that the data bus is in the input mode. This signal should be used to enable the gating of data onto the 8080A data bus from memory or I/O.

READY (input)

READY; the READY signal indicates to the 8080A that valid memory or input data is available on the 8080A data bus. This signal is used to synchronize the CPU with slower memory or I/O devices. If after sending an address out the 8080A does not receive a READY input, the 8080A will enter a WAIT state for as long as the READY line is low. READY can also be used to single step the CPU.

WAIT (output)

WAIT; the WAIT signal acknowledges that the CPU is in a WAIT state.

WR (output)

WRITE; the WR signal is used for memory WRITE or I/O output control. The data on the data bus is stable while the WR signal is active low (WR = 0).

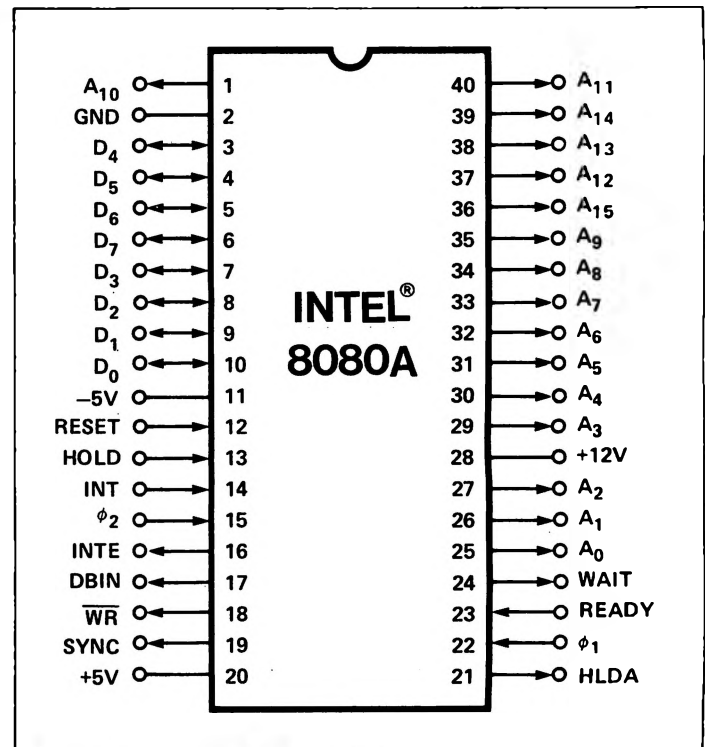
HOLD (input)

HOLD; the HOLD signal requests the CPU to enter the HOLD state. The HOLD state allows an external device to gain control of the 8080A address and data bus as soon as the 8080A has completed its use of these buses for the current machine cycle. It is recognized under the following conditions:

- the CPU is in the HALT state.
 - the CPU is in the T2 or TW state and the READY signal is active.
- As a result of entering the HOLD state the CPU ADDRESS BUS (A₁₅-A₀) and DATA BUS (D₇-D₀) will be in their high impedance state. The CPU acknowledges its state with the HOLD ACKNOWLEDGE (HLDA) pin.

HLDA (output)

HOLD ACKNOWLEDGE; the HLDA signal appears in response to the HOLD signal and indicates that the data and address bus



Pin Configuration

will go to the high impedance state. The HLDA signal begins at:

- T3 for READ memory or input.
- The Clock Period following T3 for WRITE memory or OUTPUT operation.

In either case, the HLDA signal appears after the rising edge of ϕ_1 and high impedance occurs after the rising edge of ϕ_2 .

INTE (output)

INTERRUPT ENABLE; indicates the content of the internal interrupt enable flip/flop. This flip/flop may be set or reset by the Enable and Disable Interrupt instructions and inhibits interrupts from being accepted by the CPU when it is reset. It is automatically reset (disabling further interrupts) at time T1 of the instruction fetch cycle (M1) when an interrupt is accepted and is also reset by the RESET signal.

INT (input)

INTERRUPT REQUEST; the CPU recognizes an interrupt request on this line at the end of the current instruction or while halted. If the CPU is in the HOLD state or if the Interrupt Enable flip/flop is reset it will not honor the request.

RESET (input)[1]

RESET; while the RESET signal is activated, the content of the program counter is cleared. After RESET, the program will start at location 0 in memory. The INTE and HLDA flip/flops are also reset. Note that the flags, accumulator, stack pointer, and registers are not cleared.

V_{SS} Ground Reference.

V_{DD} +12 ± 5% Volts.

V_{CC} +5 ± 5% Volts.

V_{BB} -5 ± 5% Volts (substrate bias).

ϕ_1, ϕ_2 2 externally supplied clock phases. (non TTL compatible)

SILICON GATE MOS 8080 A

ABSOLUTE MAXIMUM RATINGS*

Temperature Under Bias	0°C to +70°C
Storage Temperature	-65°C to +150°C
All Input or Output Voltages	
With Respect to V_{BB}	-0.3V to +20V
V_{CC} , V_{DD} and V_{SS} With Respect to V_{BB}	-0.3V to +20V
Power Dissipation	1.5W

*COMMENT: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

D.C. CHARACTERISTICS

$T_A = 0^\circ\text{C}$ to 70°C , $V_{DD} = +12\text{V} \pm 5\%$, $V_{CC} = +5\text{V} \pm 5\%$, $V_{BB} = -5\text{V} \pm 5\%$, $V_{SS} = 0\text{V}$, Unless Otherwise Noted.

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Condition
V_{ILC}	Clock Input Low Voltage	$V_{SS}-1$		$V_{SS}+0.8$	V	$I_{OL} = 1.9\text{mA}$ on all outputs, $I_{OH} = -150\mu\text{A}$.
V_{IHC}	Clock Input High Voltage	9.0		$V_{DD}+1$	V	
V_{IL}	Input Low Voltage	$V_{SS}-1$		$V_{SS}+0.8$	V	
V_{IH}	Input High Voltage	3.3		$V_{CC}+1$	V	
V_{OL}	Output Low Voltage			0.45	V	
V_{OH}	Output High Voltage	3.7			V	
$I_{DD(AV)}$	Avg. Power Supply Current (V_{DD})		40	70	mA	Operation $T_{CY} = .48\mu\text{sec}$
$I_{CC(AV)}$	Avg. Power Supply Current (V_{CC})		60	80	mA	
$I_{BB(AV)}$	Avg. Power Supply Current (V_{BB})		.01	1	mA	
I_{IL}	Input Leakage			± 10	μA	$V_{SS} \leq V_{IN} \leq V_{CC}$
I_{CL}	Clock Leakage			± 10	μA	$V_{SS} \leq V_{CLOCK} \leq V_{DD}$
$I_{DL}^{[2]}$	Data Bus Leakage in Input Mode			-100 -2.0	μA mA	$V_{SS} \leq V_{IN} \leq V_{SS}+0.8\text{V}$ $V_{SS}+0.8\text{V} \leq V_{IN} \leq V_{CC}$
I_{FL}	Address and Data Bus Leakage During HOLD			+10 -100	μA	$V_{ADDR/DATA} = V_{CC}$ $V_{ADDR/DATA} = V_{SS} + 0.45\text{V}$

CAPACITANCE

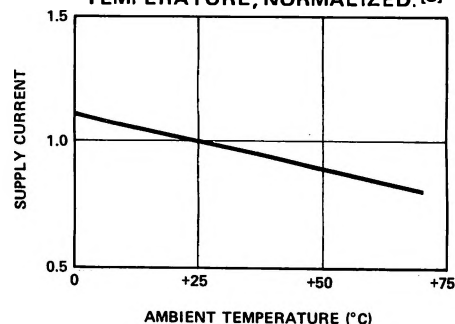
$T_A = 25^\circ\text{C}$ $V_{CC} = V_{DD} = V_{SS} = 0\text{V}$, $V_{BB} = -5\text{V}$

Symbol	Parameter	Typ.	Max.	Unit	Test Condition
C_ϕ	Clock Capacitance	17	25	pf	$f_c = 1\text{MHz}$ Unmeasured Pins Returned to V_{SS}
C_{IN}	Input Capacitance	6	10	pf	
C_{OUT}	Output Capacitance	10	20	pf	

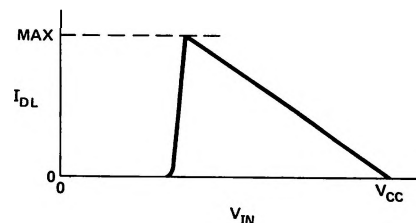
NOTES:

- The RESET signal must be active for a minimum of 3 clock cycles.
- When DBIN is high and $V_{IN} > V_{IH}$ an internal active pull up will be switched onto the Data Bus.
- $\Delta I \text{ supply} / \Delta T_A = -0.45\%/^\circ\text{C}$.

TYPICAL SUPPLY CURRENT VS. TEMPERATURE, NORMALIZED. [3]



DATA BUS CHARACTERISTIC DURING DBIN



SILICON GATE MOS 8080A

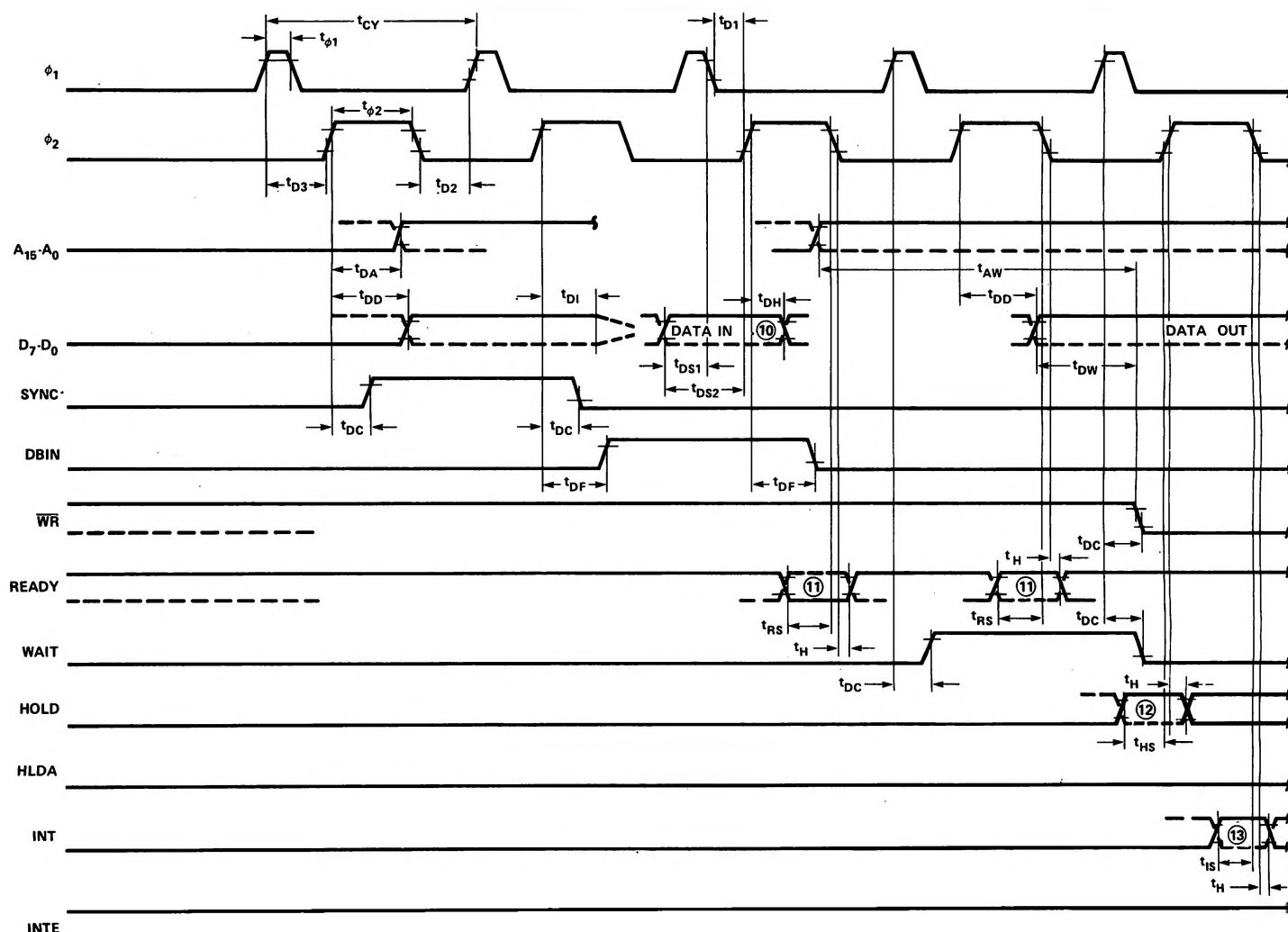
A.C. CHARACTERISTICS

$T_A = 0^\circ\text{C}$ to 70°C , $V_{DD} = +12\text{V} \pm 5\%$, $V_{CC} = +5\text{V} \pm 5\%$, $V_{BB} = -5\text{V} \pm 5\%$, $V_{SS} = 0\text{V}$, Unless Otherwise Noted

Symbol	Parameter	Min.	Max.	Unit	Test Condition
$t_{CY}^{[3]}$	Clock Period	0.48	2.0	μsec	
t_r, t_f	Clock Rise and Fall Time	0	50	nsec	
$t_{\phi 1}$	ϕ_1 Pulse Width	60		nsec	
$t_{\phi 2}$	ϕ_2 Pulse Width	220		nsec	
t_{D1}	Delay ϕ_1 to ϕ_2	0		nsec	
t_{D2}	Delay ϕ_2 to ϕ_1	70		nsec	
t_{D3}	Delay ϕ_1 to ϕ_2 Leading Edges	80		nsec	
$t_{DA}^{[2]}$	Address Output Delay From ϕ_2		200	nsec	$C_L = 100\text{pf}$
$t_{DD}^{[2]}$	Data Output Delay From ϕ_2		220	nsec	
$t_{DC}^{[2]}$	Signal Output Delay From ϕ_1 , or ϕ_2 (SYNC, \overline{WR} , WAIT, HLDA)		120	nsec	$C_L = 50\text{pf}$
$t_{DF}^{[2]}$	DBIN Delay From ϕ_2	25	140	nsec	
$t_{DI}^{[1]}$	Delay for Input Bus to Enter Input Mode		t_{DF}	nsec	
t_{DS1}	Data Setup Time During ϕ_1 and DBIN	30		nsec	

TIMING WAVEFORMS ^[14]

(Note: Timing measurements are made at the following reference voltages: CLOCK "1" = 8.0V
"0" = 1.0V; INPUTS "1" = 3.3V, "0" = 0.8V; OUTPUTS "1" = 2.0V, "0" = 0.8V.)



SILICON GATE MOS 8080A

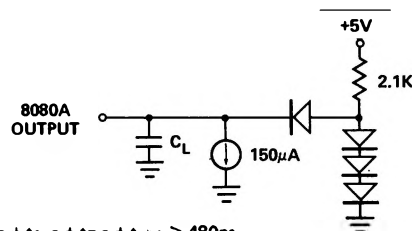
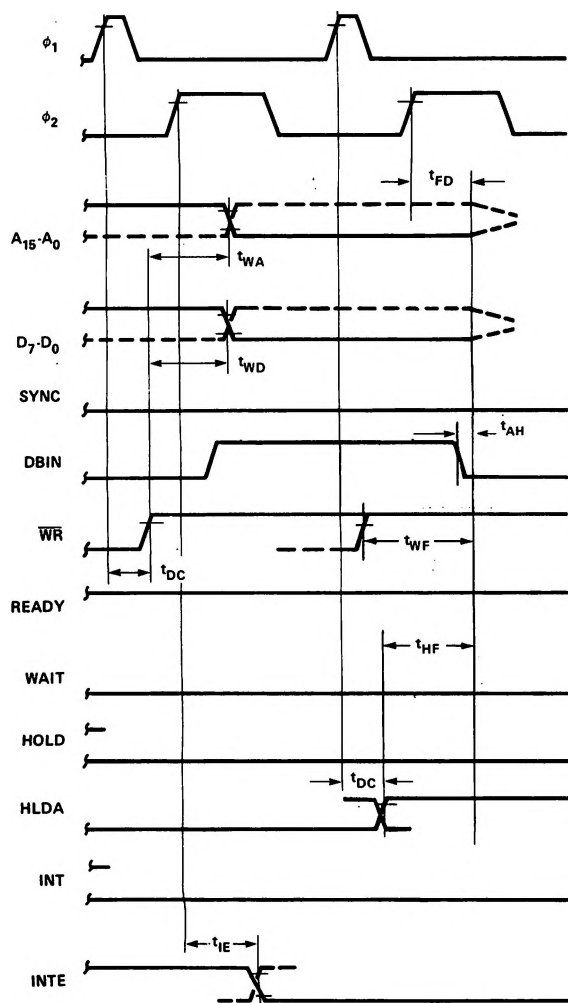
A.C. CHARACTERISTICS (Continued)

$T_A = 0^\circ\text{C}$ to 70°C , $V_{DD} = +12\text{V} \pm 5\%$, $V_{CC} = +5\text{V} \pm 5\%$, $V_{BB} = -5\text{V} \pm 5\%$, $V_{SS} = 0\text{V}$, Unless Otherwise Noted

Symbol	Parameter	Min.	Max.	Unit	Test Condition
t_{DS2}	Data Setup Time to ϕ_2 During DBIN	150		nsec	$C_L = 50\text{pf}$
$t_{DH}^{[1]}$	Data Hold Time From ϕ_2 During DBIN	[1]		nsec	
$t_{IE}^{[2]}$	INTE Output Delay From ϕ_2		200	nsec	
t_{RS}	READY Setup Time During ϕ_2	120		nsec	
t_{HS}	HOLD Setup Time to ϕ_2	140		nsec	
t_{IS}	INT Setup Time During ϕ_2 (During ϕ_1 in Halt Mode)	120		nsec	
t_H	Hold Time From ϕ_2 (READY, INT, HOLD)	0		nsec	
t_{FD}	Delay to Float During Hold (Address and Data Bus)		120	nsec	$C_L = 100\text{pf}$: Address, Data $C_L = 50\text{pf}$: \overline{WR} , HLDA, DBIN
$t_{AW}^{[2]}$	Address Stable Prior to \overline{WR}	[5]		nsec	
$t_{DW}^{[2]}$	Output Data Stable Prior to \overline{WR}	[6]		nsec	
$t_{WD}^{[2]}$	Output Data Stable From \overline{WR}	[7]		nsec	
$t_{WA}^{[2]}$	Address Stable From \overline{WR}	[7]		nsec	
$t_{HF}^{[2]}$	HLDA to Float Delay	[8]		nsec	
$t_{WF}^{[2]}$	\overline{WR} to Float Delay	[9]		nsec	
$t_{AH}^{[2]}$	Address Hold Time After DBIN During HLDA	-20		nsec	

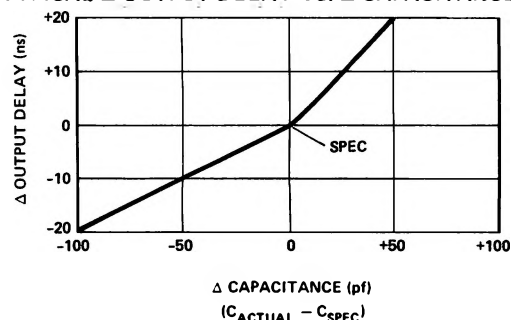
NOTES:

- Data input should be enabled with DBIN status. No bus conflict can then occur and data hold time is assured. $t_{DH} = 50\text{ns}$ or t_{DF} , whichever is less.
- Load Circuit.



- $t_{CY} = t_{D3} + t_{r\phi 2} + t_{\phi 2} + t_{f\phi 2} + t_{D2} + t_{r\phi 1} \geq 480\text{ns}$.

TYPICAL Δ OUTPUT DELAY VS. Δ CAPACITANCE



- The following are relevant when interfacing the 8080A to devices having $V_{IH} = 3.3\text{V}$:
 - Maximum output rise time from .8V to 3.3V = 100ns @ $C_L = \text{SPEC}$.
 - Output delay when measured to 3.0V = SPEC + 60ns @ $C_L = \text{SPEC}$.
 - If $C_L \neq \text{SPEC}$, add .6ns/pF if $C_L > C_{\text{SPEC}}$, subtract .3ns/pF (from modified delay) if $C_L < C_{\text{SPEC}}$.
- $t_{AW} = 2 t_{CY} - t_{D3} - t_{r\phi 2} - 140\text{nsec}$.
- $t_{DW} = t_{CY} - t_{D3} - t_{r\phi 2} - 170\text{nsec}$.
- If not HLDA, $t_{WD} = t_{WA} = t_{D3} + t_{r\phi 2} + 10\text{ns}$. If HLDA, $t_{WD} = t_{WA} = t_{WF}$.
- $t_{HF} = t_{D3} + t_{r\phi 2} - 50\text{ns}$.
- $t_{WF} = t_{D3} + t_{r\phi 2} - 10\text{ns}$.
- Data in must be stable for this period during DBIN $\cdot T_3$. Both t_{DS1} and t_{DS2} must be satisfied.
- Ready signal must be stable for this period during T_2 or T_{WH} . (Must be externally synchronized.)
- Hold signal must be stable for this period during T_2 or T_{WH} when entering hold mode, and during T_3 , T_4 , T_5 and T_{WH} when in hold mode. (External synchronization is not required.)
- Interrupt signal must be stable during this period of the last clock cycle of any instruction in order to be recognized on the following instruction. (External synchronization is not required.)
- This timing diagram shows timing relationships only; it does not represent any specific machine cycle.

INSTRUCTION SET

The accumulator group instructions include arithmetic and logical operators with direct, indirect, and immediate addressing modes.

Move, load, and store instruction groups provide the ability to move either 8 or 16 bits of data between memory, the six working registers and the accumulator using direct, indirect, and immediate addressing modes.

The ability to branch to different portions of the program is provided with jump, jump conditional, and computed jumps. Also the ability to call to and return from sub-routines is provided both conditionally and unconditionally. The RESTART (or single byte call instruction) is useful for interrupt vector operation.

Double precision operators such as stack manipulation and double add instructions extend both the arithmetic and interrupt handling capability of the 8080A. The ability to

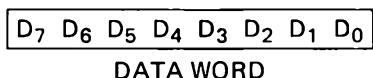
increment and decrement memory, the six general registers and the accumulator is provided as well as extended increment and decrement instructions to operate on the register pairs and stack pointer. Further capability is provided by the ability to rotate the accumulator left or right through or around the carry bit.

Input and output may be accomplished using memory addresses as I/O ports or the directly addressed I/O provided for in the 8080A instruction set.

The following special instruction group completes the 8080A instruction set: the NOP instruction, HALT to stop processor execution and the DAA instructions provide decimal arithmetic capability. STC allows the carry flag to be directly set, and the CMC instruction allows it to be complemented. CMA complements the contents of the accumulator and XCHG exchanges the contents of two 16-bit register pairs directly.

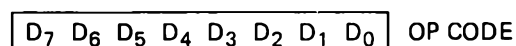
Data and Instruction Formats

Data in the 8080A is stored in the form of 8-bit binary integers. All data transfers to the system data bus will be in the same format.

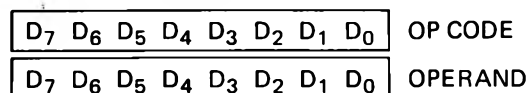


The program instructions may be one, two, or three bytes in length. Multiple byte instructions must be stored in successive words in program memory. The instruction formats then depend on the particular operation executed.

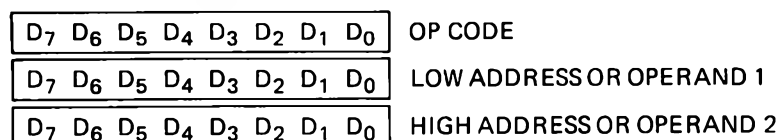
One Byte Instructions



Two Byte Instructions



Three Byte Instructions



For the 8080A a logic "1" is defined as a high level and a logic "0" is defined as a low level.

TYPICAL INSTRUCTIONS

Register to register, memory reference, arithmetic or logical, rotate, return, push, pop, enable or disable
Interrupt instructions

Immediate mode or I/O instructions

Jump, call or direct load and store instructions

SILICON GATE MOS 8080A

INSTRUCTION SET

Summary of Processor Instructions

Mnemonic	Description	Instruction Code ^[1]								Clock ^[2] Cycles
		D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀	
MOV _{r1,r2}	Move register to register	0	1	D	D	0	S	S	S	5
MOV _{M,r}	Move register to memory	0	1	1	1	0	S	S	S	7
MOV _{r,M}	Move memory to register	0	1	D	D	D	1	1	0	7
HLT	Halt	0	1	1	1	0	1	1	0	7
MVI _r	Move immediate register	0	0	D	D	D	1	1	0	7
MVI _M	Move immediate memory	0	0	1	1	0	1	1	0	10
INR _r	Increment register	0	0	D	D	D	1	0	0	5
OCR _r	Decrement register	0	0	D	D	D	1	0	1	5
INR _M	Increment memory	0	0	1	1	0	1	0	0	10
DCR _M	Decrement memory	0	0	1	1	0	1	0	1	10
ADD _r	Add register to A	1	0	0	0	0	S	S	S	4
ADC _r	Add register to A with carry	1	0	0	0	1	S	S	S	4
SUB _r	Subtract register from A	1	0	0	1	0	S	S	S	4
SBB _r	Subtract register from A with borrow	1	0	0	1	1	S	S	S	4
ANA _r	And register with A	1	0	1	0	0	S	S	S	4
XRA _r	Exclusive Or register with A	1	0	1	0	1	S	S	S	4
ORA _r	Or register with A	1	0	1	1	0	S	S	S	4
CMP _r	Compare register with A	1	0	1	1	1	S	S	S	4
ADD _M	Add memory to A	1	0	0	0	0	1	1	0	7
ADC _M	Add memory to A with carry	1	0	0	0	1	1	1	0	7
SUB _M	Subtract memory from A	1	0	0	1	0	1	1	0	7
SBB _M	Subtract memory from A with borrow	1	0	0	1	1	1	1	0	7
ANA _M	And memory with A	1	0	1	0	0	1	1	0	7
XRA _M	Exclusive Or memory with A	1	0	1	0	1	1	1	0	7
ORA _M	Or memory with A	1	0	1	1	0	1	1	0	7
CMP _M	Compare memory with A	1	0	1	1	1	1	1	0	7
ADI	Add immediate to A	1	1	0	0	0	1	1	0	7
ACI	Add immediate to A with carry	1	1	0	0	1	1	1	0	7
SUI	Subtract immediate from A	1	1	0	1	0	1	1	0	7
SBI	Subtract immediate from A with borrow	1	1	0	1	1	1	1	0	7
ANI	And immediate with A	1	1	1	0	0	1	1	0	7
XRI	Exclusive Or immediate with A	1	1	1	0	1	1	1	0	7
ORI	Or immediate with A	1	1	1	1	0	1	1	0	7
CPI	Compare immediate with A	1	1	1	1	1	1	1	0	7
RLC	Rotate A left	0	0	0	0	0	1	1	1	4
RRC	Rotate A right	0	0	0	0	1	1	1	1	4
RAL	Rotate A left through carry	0	0	0	1	0	1	1	1	4
RAR	Rotate A right through carry	0	0	0	1	1	1	1	1	4
JMP	Jump unconditional	1	1	0	0	0	0	1	1	10
JC	Jump on carry	1	1	0	1	1	0	1	0	10
JNC	Jump on no carry	1	1	0	1	0	0	1	0	10
JZ	Jump on zero	1	1	0	0	1	0	1	0	10
JNZ	Jump on no zero	1	1	0	0	0	0	1	0	10
JP	Jump on positive	1	1	1	1	0	0	1	0	10
JM	Jump on minus	1	1	1	1	1	0	1	0	10
JPE	Jump on parity even	1	1	1	0	1	0	1	0	10
JPO	Jump on parity odd	1	1	1	0	0	0	1	0	10
CALL	Call unconditional	1	1	0	0	1	1	0	1	17
CC	Call on carry	1	1	0	1	1	1	0	0	11/17
CNC	Call on no carry	1	1	0	1	0	1	0	0	11/17
CZ	Call on zero	1	1	0	0	1	1	0	0	11/17
CNZ	Call on no zero	1	1	0	0	0	1	0	0	11/17
CP	Call on positive	1	1	1	1	0	1	0	0	11/17
CM	Call on minus	1	1	1	1	1	1	0	0	11/17
CPE	Call on parity even	1	1	1	0	1	1	0	0	11/17
CPO	Call on parity odd	1	1	1	0	0	1	0	0	11/17
RET	Return	1	1	0	0	1	0	0	1	10
RC	Return on carry	1	1	0	1	1	0	0	0	5/11
RNC	Return on no carry	1	1	0	1	0	0	0	0	5/11
RZ	Return on zero	1	1	0	0	1	0	0	0	5/11
RNZ	Return on no zero	1	1	0	0	0	0	0	0	5/11
RP	Return on positive	1	1	1	1	0	0	0	0	5/11
RM	Return on minus	1	1	1	1	1	0	0	0	5/11
RPE	Return on parity even	1	1	1	0	1	0	0	0	5/11
RPO	Return on parity odd	1	1	1	0	0	0	0	0	5/11
RST	Restart	1	1	A	A	A	1	1	1	11
IN	Input	1	1	0	1	1	0	1	1	10
OUT	Output	1	1	0	1	0	0	1	1	10
LXI _B	Load immediate register Pair B & C	0	0	0	0	0	0	0	1	10
LXI _D	Load immediate register Pair D & E	0	0	0	1	0	0	0	1	10
LXI _H	Load immediate register Pair H & L	0	0	1	0	0	0	0	1	10
LXI _{SP}	Load immediate stack pointer	0	0	1	1	0	0	0	1	10
PUSH _B	Push register Pair B & C on stack	1	1	0	0	0	1	0	1	11
PUSH _D	Push register Pair D & E on stack	1	1	0	1	0	1	0	1	11
PUSH _H	Push register Pair H & L on stack	1	1	1	0	0	1	0	1	11
PUSH _{PSW}	Push A and Flags on stack	1	1	1	1	0	1	0	1	11
POP _B	Pop register pair B & C off stack	1	1	0	0	0	0	0	1	10
POP _D	Pop register pair D & E off stack	1	1	0	1	0	0	0	1	10
POP _H	Pop register pair H & L off stack	1	1	1	0	0	0	0	1	10
POP _{PSW}	Pop A and Flags off stack	1	1	1	1	0	0	0	1	10
STA	Store A direct	0	0	1	1	0	0	1	0	13
LDA	Load A direct	0	0	1	1	1	0	1	0	13
XCHG	Exchange D & E, H & L Registers	1	1	1	0	1	0	1	1	4
XTHL	Exchange top of stack, H & L	1	1	1	0	0	0	1	1	18
SPHL	H & L to stack pointer	1	1	1	1	1	0	0	1	5
PCHL	H & L to program counter	1	1	1	0	1	0	0	1	5
DAD _B	Add B & C to H & L	0	0	0	0	1	0	0	1	10
DAD _D	Add D & E to H & L	0	0	0	1	1	0	0	1	10
DAD _H	Add H & L to H & L	0	0	1	0	1	0	0	1	10
DAD _{SP}	Add stack pointer to H & L	0	0	1	1	1	0	0	1	10
STAX _B	Store A indirect	0	0	0	0	0	0	1	0	7
STAX _D	Store A indirect	0	0	0	1	0	0	1	0	7
LDAX _B	Load A indirect	0	0	0	0	1	0	1	0	7
LDAX _D	Load A indirect	0	0	0	1	1	0	1	0	7
INX _B	Increment B & C registers	0	0	0	0	0	0	1	1	5
INX _D	Increment D & E registers	0	0	0	1	0	0	1	1	5
INX _H	Increment H & L registers	0	0	1	0	0	0	1	1	5
INX _{SP}	Increment stack pointer	0	0	1	1	0	0	1	1	5
DCX _B	Decrement B & C	0	0	0	0	1	0	1	1	5
DCX _D	Decrement D & E	0	0	0	1	1	0	1	1	5
DCX _H	Decrement H & L	0	0	1	0	1	0	1	1	5
DCX _{SP}	Decrement stack pointer	0	0	1	1	1	0	1	1	5
CMA	Complement A	0	0	1	0	1	1	1	1	4
STC	Set carry	0	0	1	1	0	1	1	1	4
CMC	Complement carry	0	0	1	1	1	1	1	1	4
DAA	Decimal adjust A	0	0	1	0	0	1	1	1	4
SHLD	Store H & L direct	0	0	1	0	0	0	1	0	16
LHLD	Load H & L direct	0	0	1	0	1	0	1	0	16
EI	Enable Interrupts	1	1	1	1	1	0	1	1	4
DI	Disable interrupt	1	1	1	1	0	0	1	1	4
NOP	No-operation	0	0	0	0	0	0	0	0	4

NOTES: 1. DDD or SSS — 000 B — 001 C — 010 D — 011 E — 100 H — 101 L — 110 Memory — 111 A.

2. Two possible cycle times, (5/11) indicate instruction cycles dependent on condition flags.